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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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 μ PA1755

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is Dual N-channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

FEATURES

- · Dual chip type
- · Low on-resistance

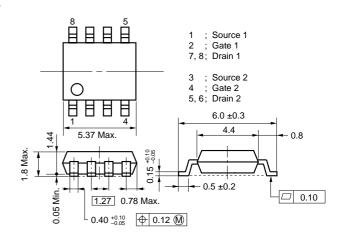
 $R_{DS(on)1} = 32 \text{ m}\Omega \text{ MAX}. \text{ (Vgs} = 10 \text{ V, ID} = 3.5 \text{ A)}$ $R_{DS(on)2} = 45 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = 4.5 \text{ V, Ip} = 3.5 \text{ A)}$

- Low input capacitance Ciss = 895 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1755G	Power SOP8

PACKAGE DRAWING (Unit: mm)

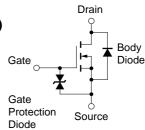


EQUIVALENT CIRCUIT

(1/2 Circuit)

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, All terminals are connected.)

Drain to Source Voltage (Vss = 0)	VDSS	30	V
Gate to Source Voltage (Vps = 0)	Vgss	±20	V
Drain Current (DC)	I _{D(DC)}	±7.0	Α
Drain Current (pulse) Note1	I _{D(pulse)}	±28	Α
Total Power Dissipation (1 unit) Note2	PT	1.7	W
Total Power Dissipation (2 unit) Note2	PT	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	T_{stg}	-55 to + 150	°C



Notes 1. PW \leq 10 μ s, Duty cycle \leq 1 %

2. $T_A = 25 \, ^{\circ}\text{C}$, Mounted on ceramic substrate of 2000 mm² x 1.1 mm

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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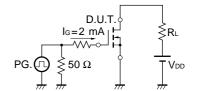
ELECTRICAL CHARACTERISTICS (T_A = 25 °C, All terminals are connected.)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Ip = 3.5 A		22	32	mΩ
	RDS(on)2	Vgs = 4.5 V, ID = 3.5 A		32	45	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	>
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 3.5 A	4.0	8.0		S
Drain Leakage Current	IDSS	V _{DS} = 30 V, V _{GS} = 0			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0			±10	μΑ
Input Capacitance	Ciss	V _{DS} = 10 V		895		pF
Output Capacitance	Coss	Vgs = 0		335		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		150		pF
Turn-on Delay Time	td(on)	ID = 3.5 A		16		ns
Rise Time	tr	V _{GS(on)} = 10 V		130		ns
Turn-off Delay Time	td(off)	VDD = 15 V		55		ns
Fall Time	tr	$R_G = 10 \Omega$		30		ns
Total Gate Charge	QG	ID = 7.0 A		19		nC
Gate to Source Charge	Qgs	V _{DD} = 24 V		2.2		nC
Gate to Drain Charge	Q _{GD}	Vgs = 10 V		5.4		nC
Body Diode forward Voltage	V _{F(S-D)}	IF = 7.0 A, VGS = 0		0.8		V
Reverse Recovery Time	trr	IF = 7.0 A, VGS = 0		45		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		62		nC

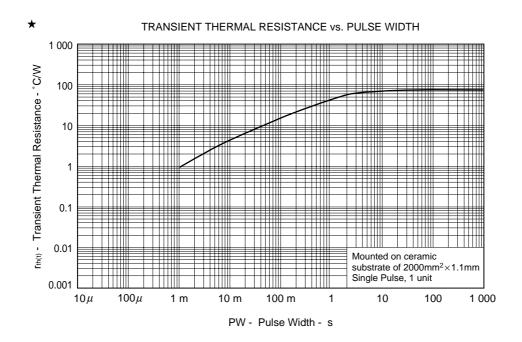
TEST CIRCUIT 1 SWITCHING TIME

$PG. \bigcap_{RG} R_{G} = 10 \ \Omega$ $V_{GS} \bigvee_{Wave Form} V_{GS} \bigvee_{VGS (en)} 90 \%$ $V_{GS} \bigvee_{Wave Form} V_{GS (en)} \bigvee_{VGS (en)} 90 \%$ $V_{GS} \bigvee_{Wave Form} V_{GS (en)} \bigvee_{VGS (en)} 90 \%$ $V_{GS} \bigvee_{VGS (en)} V_{GS (en)} \bigvee_{VG$

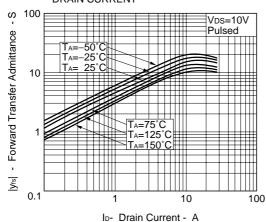
TEST CIRCUIT 2 GATE CHARGE



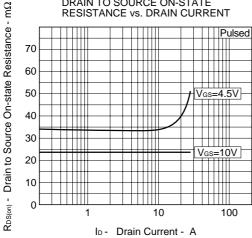
TYPICAL CHARACTERISTICS (TA = 25 °C)



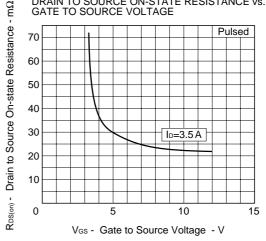


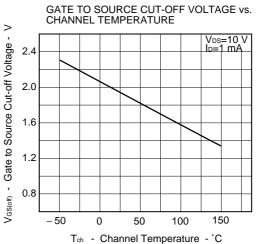


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

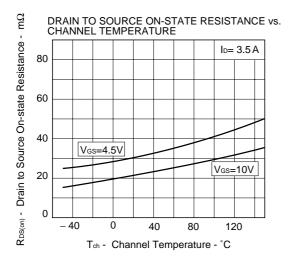


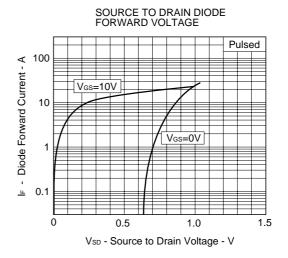
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

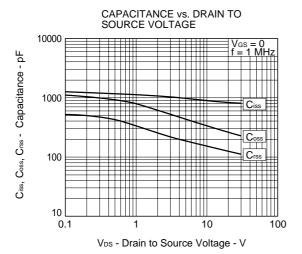


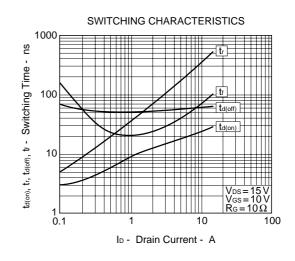


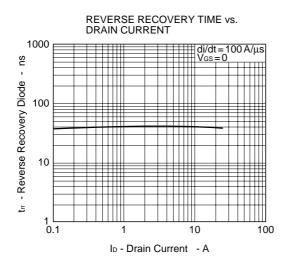
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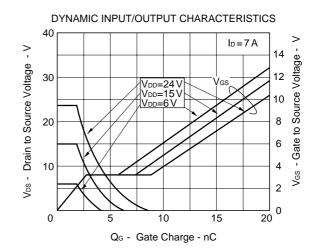




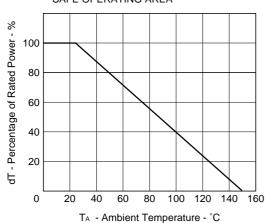




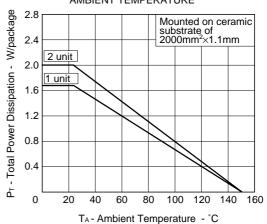




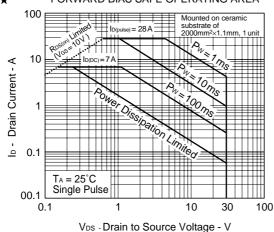
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



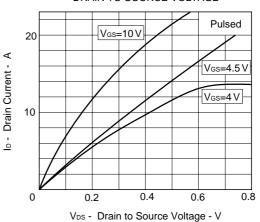
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



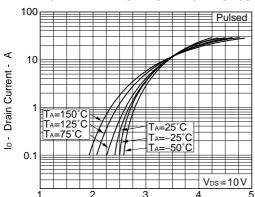
★ FORWARD BIAS SAFE OPERATING AREA



DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



FORWARD TRANSFER CHARACTERISTICS



V_{GS}- Gate to Source Voltage - V



[MEMO]



[MEMO]



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